

## HFA45HI60C

PD-20380D

Ultrafast, Soft Recovery Diode Thru-Hole (TO-259AA) 600V, 45A

### **Features**

- Dual common cathode configuration
- · Reduced RFI and EMI
- · Reduced snubbing
- Extensive characterization of recovery parameters
- Hermetic package
- Ceramic eyelets

### **Product Summary**

• **V**<sub>R</sub> (per leg): 600V

• **V<sub>F</sub>:** 1.47V

• **Q**<sub>rr</sub>: 270nC

di<sub>(rec)M</sub>/dt: 400A/μs

## **Potential Applications**

- DC-DC converter
- Motor drives

### **Product Validation**

Qualified according to MIL-PRF-19500 for space applications



### **Description**

These ultrafast, soft recovery diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and di/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motor drives and other applications where switching losses are significant portion of the total losses.

## **Ordering Information**

Table 1 Ordering options

- auto- ing options					
Part number	Package	Screening Level			
HFA45HI60C	TO-259AA	сотѕ			
HFA45HI60CSCV	TO-259AA	JANTXV-equivalent			
HFA45HI60CSCX	TO-259AA	JANTX-equivalent			
HFA45HI60CSCS	TO-259AA	S-level			

## HFA45HI60C

## FRED Ultrafast, Soft Recovery Diode



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## FRED Ultrafast, Soft Recovery Diode



**Absolute Maximum Ratings** 

# 1 Absolute Maximum Ratings

Table 2 Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
$V_R$	Cathode to anode voltage (per leg)	600	V
I <sub>F(AV)</sub>	Continuous forward current, T <sub>C</sub> = 80°C <sup>1</sup>	45	Α
I <sub>FSM</sub>	Single pulse forward current, T <sub>c</sub> = 25°C (per leg) <sup>2</sup>	225	Α
$P_D @ T_C = 25^{\circ}C$	Maximum power dissipation	104	W
T <sub>J</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to 150	°C
Wt	Weight	10.9 (Typical)	g

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<sup>&</sup>lt;sup>1</sup> DC = 50% rect. wave

 $<sup>^2</sup>$  ½ sine wave, 60 Hz, Pulse width = 8.33 ms



**Device Characteristics** 

### 2 Device Characteristics

### 2.1 Electrical Characteristics

Table 3 Electrical Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
$V_{BR}$	Cathode Anode Breakdown Voltage	600	_		V	$I_R = 100 \mu A$
		_	_	1.37	V	I <sub>F</sub> = 22A, T <sub>J</sub> = -55°C
V	Forward Voltage Drop (Per Leg) See Fig. 1	-	_	1.47	V	I <sub>F</sub> = 22A, T <sub>J</sub> = 25°C
$V_{F}$		_	_	1.81	V	I <sub>F</sub> = 45A, T <sub>J</sub> = 25°C
		-	_	1.37	V	I <sub>F</sub> = 22A, T <sub>J</sub> = 125°C
	Reverse Leakage Current	_	_	10	μΑ	$V_R = V_R$ Rated
$I_R$	(Per Leg) See Fig. 2	_	_	1.0	mA	V <sub>R</sub> = 480V, T <sub>J</sub> = 125°C
CJ	Junction Capacitance (Per Leg) See Fig. 3	_	_	65	pF	V <sub>R</sub> = 200V
Ls	Series Inductance (Per Leg)	_	8.7	_	nH	Measured from anode lead to cathode lead, 6mm (0.025 in) from package

## 2.2 Dynamic Recovery Characteristics

Table 4 Dynamic Recovery Characteristics

Symbol	Parameter	Min.	Тур.	Мах.	Unit	<b>Test Condition</b>	S
t <sub>rr</sub>	Reverse Recovery Time (Per Leg)	_	_	97	ns	$I_F = 22A, V_R = 200$	0V, d <sub>if</sub> /dt = 200A/μs
t <sub>rr1</sub>	Reverse Recovery Time	_	97	_		T <sub>J</sub> = 25°C	
t <sub>rr2</sub>	(Per Leg) See Fig. 5	_	194	_	ns	T <sub>J</sub> = 125°C	I <sub>F</sub> = 45A
I <sub>RRM1</sub>	Peak Recovery Current	_	7.5	_		T <sub>J</sub> = 25°C	
I <sub>RRM2</sub>	(Per Leg) See Fig. 6	_	12	_	A	T <sub>J</sub> = 125°C	V <sub>R</sub> = 480V
Q <sub>rr1</sub>	Reverse Recovery Charge	_	270	_		T <sub>J</sub> = 25°C	
Q <sub>rr2</sub>	(Per Leg) See Fig. 7	_	1210	_	nC	T <sub>J</sub> = 125°C	$d_{if}/dt = 200 A/ \mu s$
$\overline{di_{(rec)M}/dt_1}$	Peak Rate of Fall of Recovery	_	400	_		T <sub>J</sub> = 25°C	
di <sub>(rec)M</sub> /dt <sub>2</sub>	Current During t₀ (Per Leg) See Fig. 8	_	100	_	A/ μs	T <sub>J</sub> = 125°C	

### 2.3 Thermal-Mechanical Characteristics

 Table 5
 Thermal-Mechanical Characteristics

Symbol	Parameter		Max.	Unit
$R_{ heta JC}$	Junction to Case, Single Leg Conducting		1.2	°C/W

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### **Electrical Characteristics Curves**

### 3 Electrical Characteristics Curves

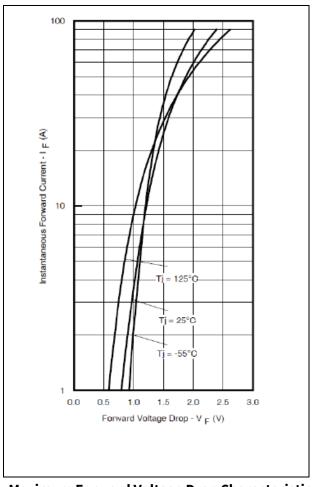


Figure 1 Maximum Forward Voltage Drop Characteristics (Per Leg)

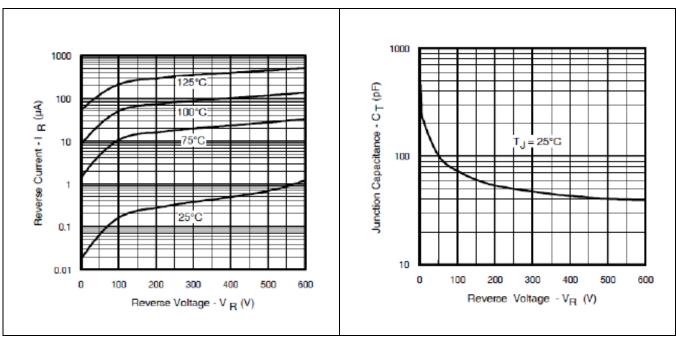


Figure 2 Typical Values of Reverse Current Vs. Reverse Voltage (Per Leg)

Figure 3

Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

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### **Electrical Characteristics Curves**

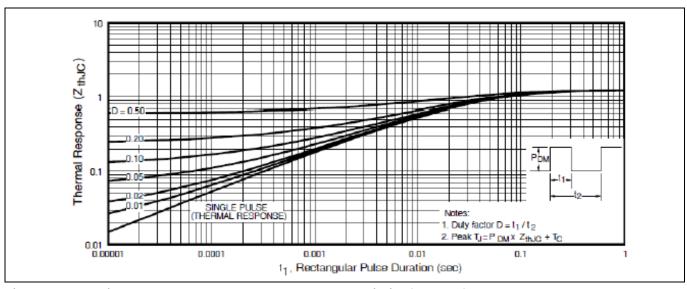


Figure 4 Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (Per Leg)

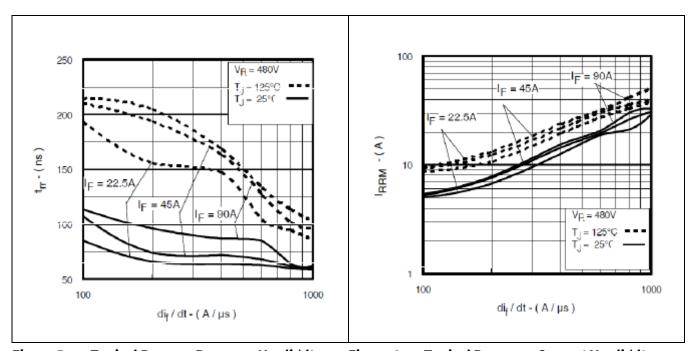


Figure 5 Typical Reverse Recovery Vs.  $di_f/dt$  (Per Leg)

Figure 6 Typical Recovery Current Vs. di<sub>f</sub>/dt (Per Leg)

### **FRED Ultrafast, Soft Recovery Diode**



### **Electrical Characteristics Curves**

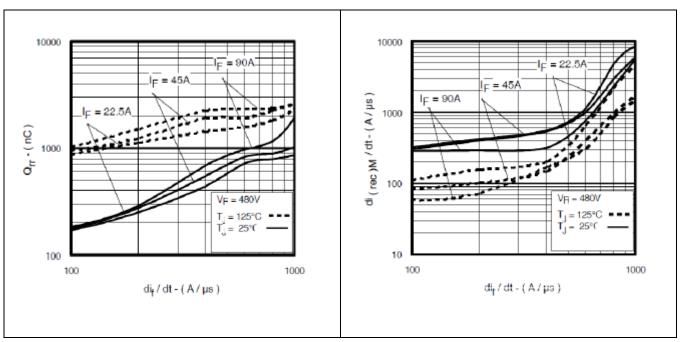


Figure 7 Typical Stored Charge Vs. di<sub>f</sub>/dt (Per Leg)

 $Figure \, 8 \qquad Typical \, di_{(rec)M}/dt \, Vs. \, di_f/dt \, (Per \, Leg)$ 



**Test Circuit** 

### 4 Test Circuit

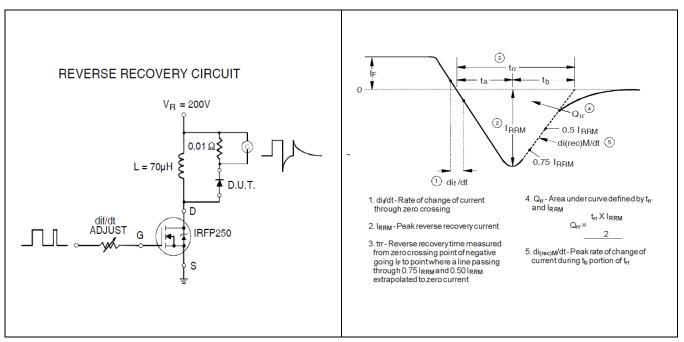


Figure 9 Reverse Recovery Parameter Test
Circuit

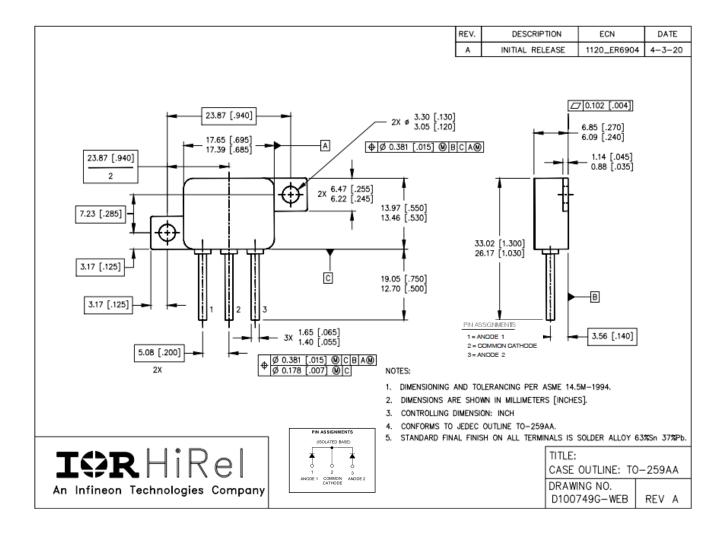
Figure 10 Reverse Recovery Waveform and Definitions



**Package Outline** 

## 5 Package Outline

Note: For the most updated package outline, please see the website: TO-259AA



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# FRED Ultrafast, Soft Recovery Diode



**Revision history** 

# **Revision history**

Document version	Date of release	Description of changes	
	04/17/2001	Final datasheet (PD-20368)	
Rev A	03/07/2013	Updated per ECN-1120_00911	
Rev B	06/02/2022	Updated per ECN-1120-08972	

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